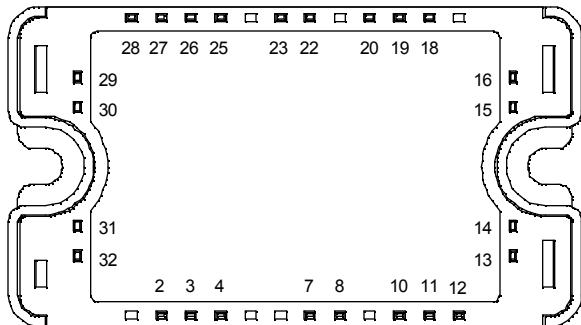
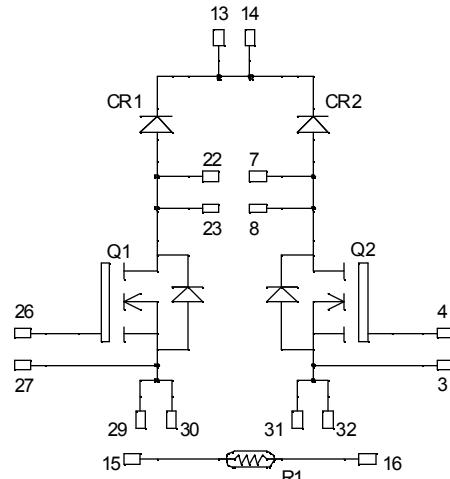


**Dual boost chopper
Super Junction MOSFET
Power Module**

V_{DSS} = 600V
R_{DSon} = 70mΩ max @ T_j = 25°C
I_D = 39A @ T_c = 25°C



All multiple inputs and outputs must be shorted together
 Example: 13/14 ; 29/30 ; 22/23 ...

Absolute maximum ratings

| Symbol | Parameter | Max ratings | Unit |
|-------------------|---------------------------------------------------|------------------------------------------------|----------|
| V _{DSS} | Drain - Source Breakdown Voltage | 600 | V |
| I _D | Continuous Drain Current | T _c = 25°C T _c = 80°C | 39 29 |
| I _{DM} | Pulsed Drain current | | |
| V _{GS} | Gate - Source Voltage | ±20 | V |
| R _{DSon} | Drain - Source ON Resistance | 70 | mΩ |
| P _D | Maximum Power Dissipation | T _c = 25°C 250 | W |
| I _{AR} | Avalanche current (repetitive and non repetitive) | 20 | A |
| E _{AR} | Repetitive Avalanche Energy | 1 | mJ |
| E _{AS} | Single Pulse Avalanche Energy | 1800 | |

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

Features

• **COOLMOS**[®]
 Power Semiconductors

- Ultra low R_{DSon}
- Low Miller capacitance
- Ultra low gate charge
- Avalanche energy rated
- Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a single boost of twice the current capability
- RoHS Compliant

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|--------------|---------------------------------|---------------------------------------------------|---------------------------|-----|-----|-----------|------------------|
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0\text{V}$, $V_{DS} = 600\text{V}$ | $T_j = 25^\circ\text{C}$ | | | 25 | μA |
| | | $V_{GS} = 0\text{V}$, $V_{DS} = 600\text{V}$ | $T_j = 125^\circ\text{C}$ | | | 250 | |
| $R_{DS(on)}$ | Drain – Source on Resistance | $V_{GS} = 10\text{V}$, $I_D = 39\text{A}$ | | | | 70 | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 2.7\text{mA}$ | | 2.1 | 3 | 3.9 | V |
| I_{GSS} | Gate – Source Leakage Current | $V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{V}$ | | | | ± 100 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|--------------|------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|-----|---------------|
| C_{iss} | Input Capacitance | $V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$ | | | 7 | | nF |
| C_{oss} | Output Capacitance | | | | 2.56 | | |
| C_{rss} | Reverse Transfer Capacitance | | | | 0.21 | | |
| Q_g | Total gate Charge | $V_{GS} = 10\text{V}$ $V_{Bus} = 300\text{V}$ $I_D = 39\text{A}$ | | | 259 | | nC |
| Q_{gs} | Gate – Source Charge | | | | 29 | | |
| Q_{gd} | Gate – Drain Charge | | | | 111 | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive Switching @ 125°C $V_{GS} = 15\text{V}$ $V_{Bus} = 400\text{V}$ $I_D = 39\text{A}$ | | | 21 | | ns |
| T_r | Rise Time | | | | 30 | | |
| $T_{d(off)}$ | Turn-off Delay Time | | | | 283 | | |
| T_f | Fall Time | | $R_G = 5\Omega$ | | 84 | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 25°C $V_{GS} = 15\text{V}$, $V_{Bus} = 400\text{V}$ $I_D = 39\text{A}$, $R_G = 5\Omega$ | | | 670 | | μJ |
| E_{off} | Turn-off Switching Energy | | | | 980 | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 125°C $V_{GS} = 15\text{V}$, $V_{Bus} = 400\text{V}$ $I_D = 39\text{A}$, $R_G = 5\Omega$ | | | 1096 | | μJ |
| E_{off} | Turn-off Switching Energy | | | | 1206 | | |

Chopper diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|-----------|-----------------------------------------|---------------------------------------------------------------------------------|---------------------------|-----|------|-----|---------------|
| V_{RRM} | Maximum Peak Repetitive Reverse Voltage | | | 600 | | | V |
| I_{RM} | Maximum Reverse Leakage Current | $V_R = 600\text{V}$ | $T_j = 25^\circ\text{C}$ | | | 250 | μA |
| | | | $T_j = 125^\circ\text{C}$ | | | 500 | |
| I_F | DC Forward Current | | $T_c = 80^\circ\text{C}$ | | 40 | | A |
| V_F | Diode Forward Voltage | $I_F = 40\text{A}$ $V_{GE} = 0\text{V}$ | $T_j = 25^\circ\text{C}$ | | 1.45 | | V |
| | | | $T_j = 125^\circ\text{C}$ | | 1.35 | | |
| t_{rr} | Reverse Recovery Time | $I_F = 40\text{A}$ $V_R = 300\text{V}$ $di/dt = 2600\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$ | | 95 | | ns |
| | | | $T_j = 125^\circ\text{C}$ | | 115 | | |
| Q_{rr} | Reverse Recovery Charge | | $T_j = 25^\circ\text{C}$ | | 2.6 | | μC |
| | | | $T_j = 125^\circ\text{C}$ | | 4 | | |

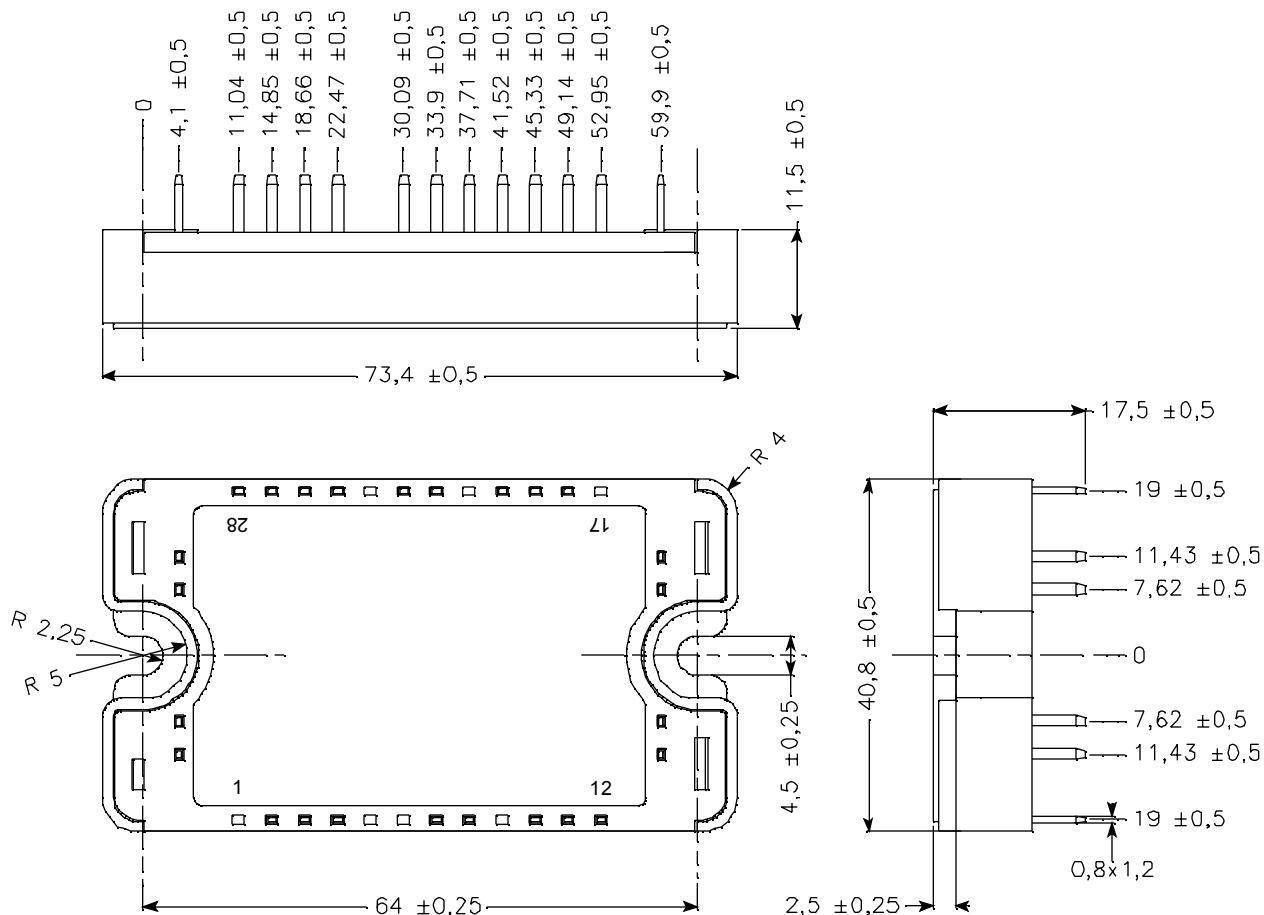
Thermal and package characteristics

| Symbol | Characteristic | | Min | Typ | Max | Unit |
|------------|------------------------------------------------------------------------------------------|-------------|-----|-----|-----|------|
| R_{thJC} | Junction to Case Thermal Resistance | Transistor | | | 0.5 | °C/W |
| | | Diode | | | 1.5 | |
| V_{ISOL} | RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1\text{mA}$, 50/60Hz | 2500 | | | | V |
| T_J | Operating junction temperature range | -40 | | 150 | | |
| T_{STG} | Storage Temperature Range | -40 | | 125 | | °C |
| T_C | Operating Case Temperature | -40 | | 100 | | |
| Torque | Mounting torque | To heatsink | M4 | 2.5 | 4.7 | N.m |
| Wt | Package Weight | | | | 110 | g |

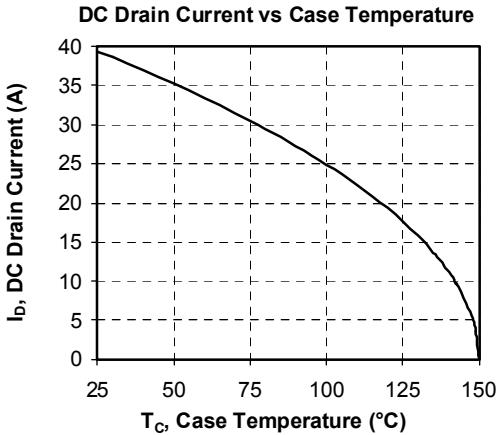
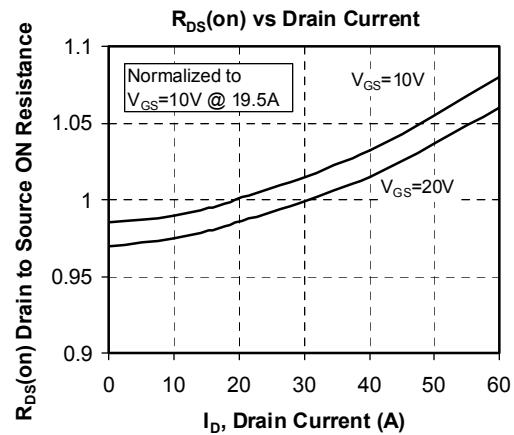
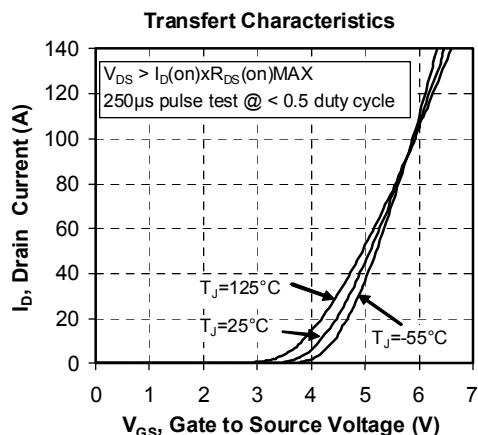
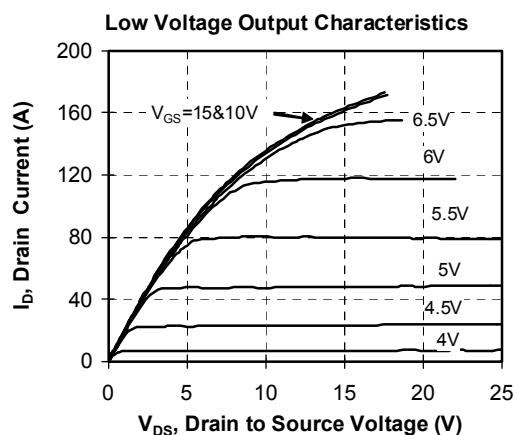
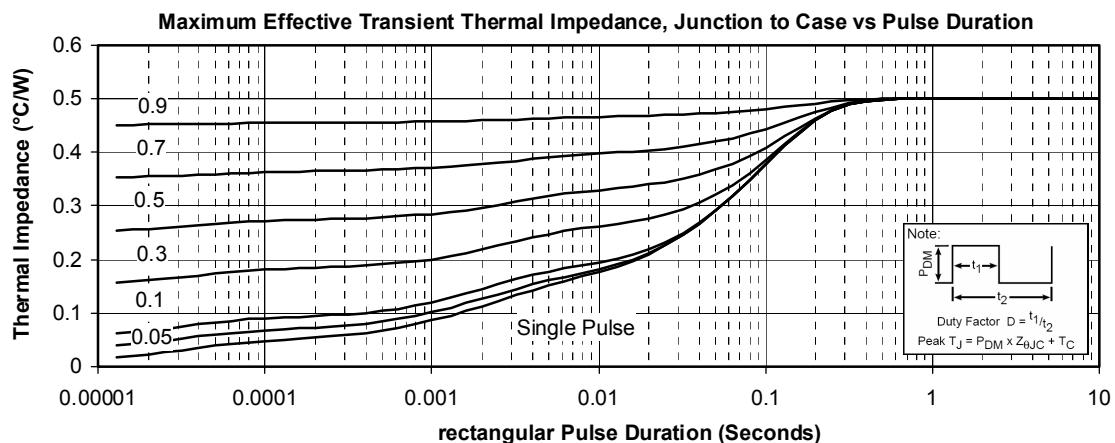
Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

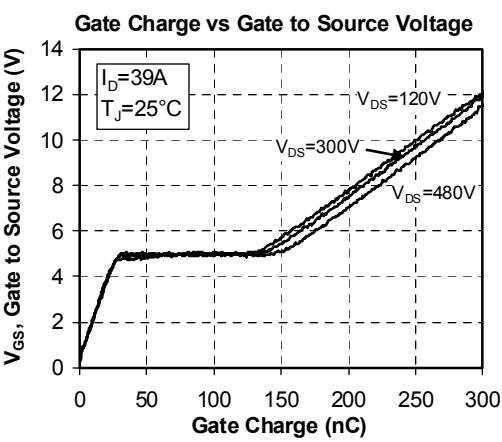
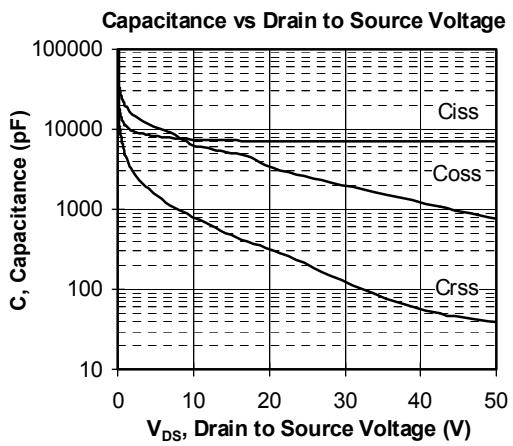
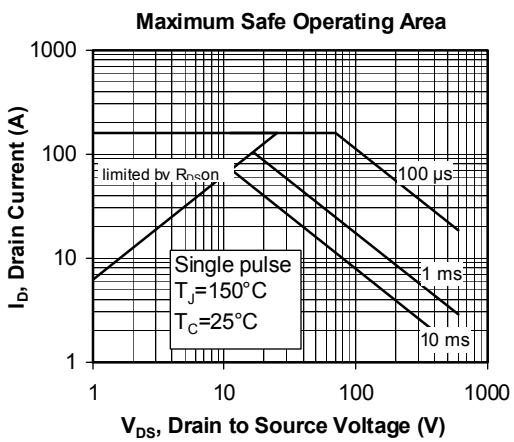
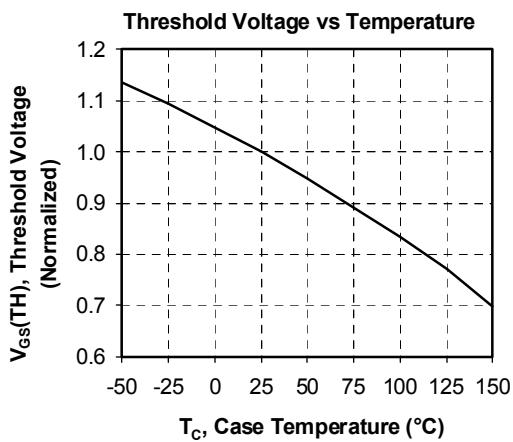
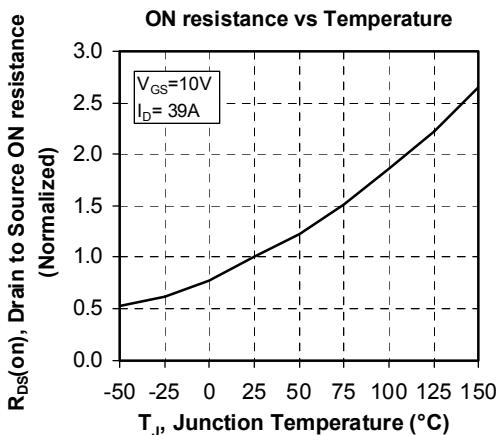
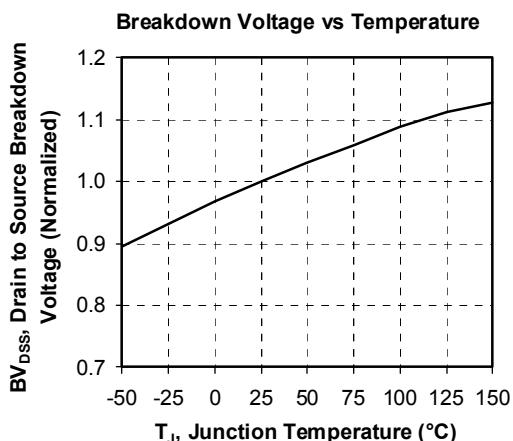
| Symbol | Characteristic | | Min | Typ | Max | Unit |
|-------------|----------------------------|--|-----|------|-----|------|
| R_{25} | Resistance @ 25°C | | | 50 | | kΩ |
| $B_{25/85}$ | $T_{25} = 298.15\text{ K}$ | | | 3952 | | K |

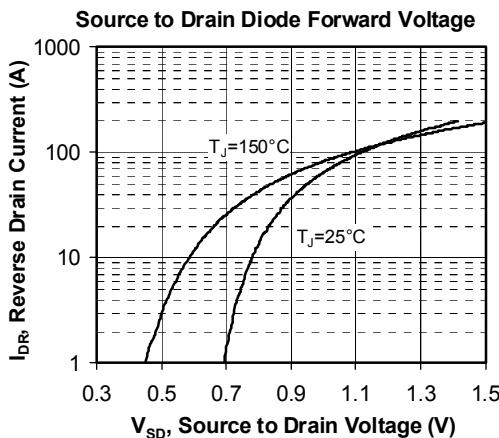
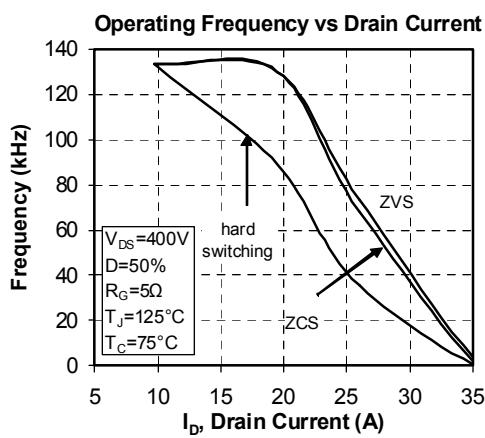
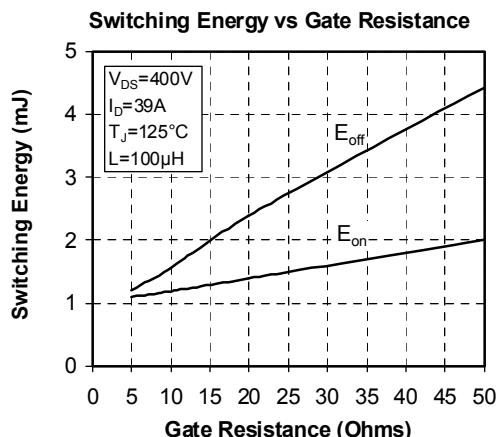
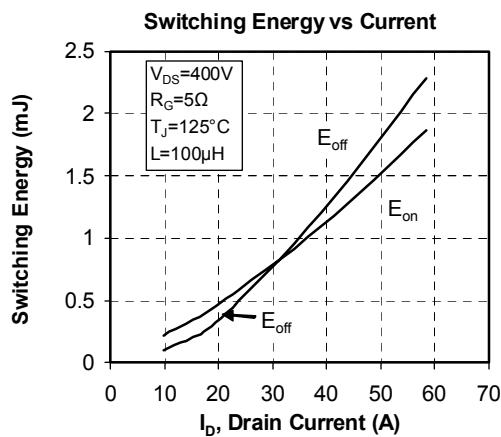
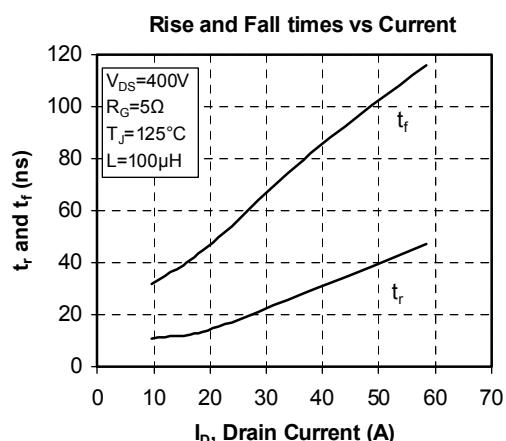
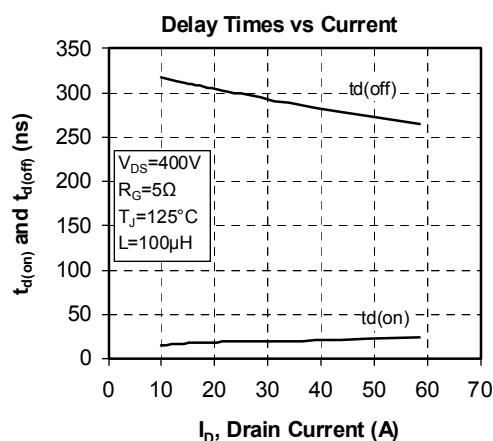
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad T: \text{ Thermistor temperature } \\ R_T: \text{ Thermistor value at } T$$

SP3 Package outline (dimensions in mm)

 See application note 1901 - Mounting Instructions for SP3 Power Modules on www.microsemi.com

Typical Performance Curve







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